In the Claims. This Listing of Claims replaces all prior versions and listings of Claims in the application.

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(Presentty Amended) A method for building a consumable

staple blank refill, the method comprising the steps of:

fabricating a plurality of arrays of consumable parts staple wires

detachably connected along a first direction;

stacking said plurality of said fabricated arrays of parts staple wires along a second direction; and

providing an adhesive bond between adjacent ones of said stacked plurality of arrays.

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2. (Presently Amended) The method of claim 1 wherein said fabricating step comprises the step of:

providing a perforated connection between said consumable parts staple

wires.

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 (Original) The method of claim 1 wherein said step of providing an adhesive bond comprises the step of:

adhering adjacent ones of said plurality of arrays using solid rub-on glue.

4. (Original) The method of claim 1 further comprising the step of: selecting a strength of said adhesive bond so as to allow separation of an array from an adjacent array only upon experiencing an application of force from an array advancement mechanism.

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(Presently Amended) The method of claim 1 further

comprising the step of:

omitting an attachment to said adhered plurality of arrays of any material requiring removal prior to consumption of said consumable parts staple wires in a host device.

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6. (Presently Amended)

The method of claim 1 further

comprising the step of:

destroying the adhesive bond during consumption of the consumable parts staple wires.

(Cancelled) A staple refill, the refill comprising:

a plurality of staple wire layers stacked along a direction normal to a plane of said layers; and

an adhesive layer disposed in between each set of adjacent surfaces of said stacked staple wire layers.

- (Cancelled) The staple refill of claim 7 wherein said adhesive is solid adhesive.
- (Cancelled) The staple refill of claim 7 wherein said layers are stacked such that all staple wires of said staple wire layers are aligned.
- 10. (Cancelled) The staple refill of claim 7 wherein said adhesive layers occupy substantially all of a surface area of said each set of adjacent surfaces.
- 1 11. (Cancelled) The staple refill of claim 7 wherein said adhesive
 layers occupy substantially less than all of a surface area of said each set of said
 adjacent surfaces.
 - 12. (Cancelled) The staple refill of claim 7 wherein said adhesive layer has a bonding force such as to allow separation of a staple wire layer from a remainder of said refill only upon experiencing an application of force from an array advancement mechanism.
- 1 13. (Cancelled) A system for fully consuming a staple refill, the system comprising:
 - means for stacking a plurality of staple wire plates; and

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4	•	means for gluing together each set of adjacent staple wire plate surfaces
5	of sa	id stacked plates.

- (Cancelled) The system of claim 13 further comprising:
- 2 means for receiving said glued stacked plates into a cartridge;
- means for separating one of said glued stacked plates from a remainder of said glued stacked plates;
- means for removing a staple from said separated glued stacked plate; and means for expelling said removed staple and any glue in contact with said
- 7 removed staple from said cartridge.
- 1 15. (Cancelled) The system of claim 13 wherein said means for stacking comprises:
- 3 means for stacking vertically.
- 1 16. (Cancelled) The system of claim 13 wherein said means for stacking comprises:
- means for stacking said plates such that all staple wires of said stacked staple wire plates are aligned.
- 1 17. (Cancelled) The system of claim 13 wherein said means for gluing comprises:
- means for applying glue to substantially all of a surface area of at least
- one of said sets of adjacent surfaces.
- 1 18. (Cancelled) The system of claim 13 wherein said means for gluing comprises:
- means for applying glue to substantially less than all of a surface area of at
- 4 least one of said sets of adjacent surfaces.